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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Mitsuo Zen

Application No.: 09/868,573

Art Unit: 1725

Filed: August 20, 2001

Examiner: L. Edmondson

For: SOLDER COATED MATERIAL  
AND METHOD FOR ITS MANUFACTURE

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

Office of Initial Patent Examination  
Filing Receipt Corrections  
United States Patent and Trademark Office  
P.O. Box 1450  
Alexandria, VA 22313-1450  
Fax: 703-746-9195

via fax

Dear Sir:

An error has been noted on the Official Filing Receipt in the referenced application. Namely, the title of the invention is incorrect. Please issue a Corrected Official Filing Receipt correcting this error as marked on the attached copy of the Official Filing Receipt.

Respectfully submitted,

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Date: March 17, 2004  
1029



## UNITED STATES PATENT AND TRADEMARK OFFICE

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| APPLICATION NUMBER | FILING DATE | GRP ART UNIT | FIL FEE REC'D | ATTY. DOCKET NO. | DRAWINGS | TOT CLAIMS | IND CLAIMS |
|--------------------|-------------|--------------|---------------|------------------|----------|------------|------------|
| 09/868,573         | 08/20/2001  | 1725         | 990           | 1029/HIROSE      |          | 1          | 1          |

CONFIRMATION NO. 1494

## FILING RECEIPT



Michael Tobias  
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Date Mailed: 09/20/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when Inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

Mitsuo Zen, Soka-shi, JAPAN;

## Domestic Priority data as claimed by applicant

THIS APPLICATION IS A 371 OF PCT/JP99/05777 10/20/1999

## Foreign Applications

Projected Publication Date: N/A

Non-Publication Request: No

Early Publication Request: No

## Title

X

Solder coating material and production method therefor

## Preliminary Class

219

CORRECT TITLE :

SOLDER COATED MATERIAL  
AND METHOD FOR ITS  
MANUFACTURE

Data entry by : ORDENEZ, MARTA

Team : OIPE

Date: 09/20/2001